Vishay Siliconix



**TO-220AB** 

**PRODUCT SUMMARY** 

V<sub>DS</sub> (V)

R<sub>DS(on)</sub> (Ω)

Q<sub>qs</sub> (nC)

Q<sub>gd</sub> (nC)

Q<sub>q</sub> max. (nC)

Configuration

G C

 $V_{GS} = -10 V$ 

P-Channel MOSFET

0.14

-60

34

9.9

16

Single

## **Power MOSFET**

### FEATURES

- Dynamic dV/dt rating
- · Repetitive avalanche rated
- P-channel
- 175 °C operating temperature
- Fast switching
- Ease of paralleling
- Simple drive requirements
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

#### Note

\* This datasheet provides information about parts that are RoHS-compliant and / or parts that are non RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details

### DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	IRF9Z34PbF
Lead (Pb)-free and halogen-free	IRF9Z34PbF-BE3

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>C</sub>	= 25 °C, un	less otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage		V <sub>DS</sub>	-60	v		
Gate-source voltage		V <sub>GS</sub>	as ± 20			
Continuous drain current	V at 10 V	T <sub>C</sub> = 25 °C	1	-18		
Continuous drain current	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 100 °C	ID	-13	А	
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	-72		
Linear derating factor			0.59	W/°C		
Single pulse avalanche energy <sup>b</sup>		E <sub>AS</sub>	370	mJ		
Repetitive avalanche current <sup>a</sup>		I <sub>AR</sub>	-18	A		
Repetitive avalanche energy <sup>a</sup>			E <sub>AR</sub>	8.8	mJ	
Maximum power dissipation	T <sub>C</sub> = 25 °C		PD	88	W	
Peak diode recovery dV/dt <sup>c</sup>			dV/dt	-4.5	V/ns	
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +175	°C		
Soldering recommendations (peak temperature) <sup>d</sup>	For 10 s			300		
Mounting torque	6-32 or M3 screw			10	lbf ∙ in	
Mounting torque				1.1	N · m	

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b.  $V_{DD} = -25 \text{ V}$ , starting  $T_J = 25 \text{ °C}$ , L = 1.3 mH,  $R_g = 25 \Omega$ ,  $I_{AS} = -18 \text{ A}$  (see fig. 12)

c.  $I_{SD} \leq -18$  A, dl/dt  $\leq 170$  A/µs,  $V_{DD} \leq V_{DS}$ ,  $T_J \leq 175$  °C

d. 1.6 mm from case

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1 For technical questions, contact: <u>hvm@vishay.com</u>





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PARAMETER	SYMBOL	TYP.		MAX.			UNIT	
Maximum junction-to-ambient	R <sub>thJA</sub>	-	- 62				0.111	
Case-to-sink, flat, greased surface	R <sub>thCS</sub>	0.50 - 1.7				°C/W		
Maximum junction-to-case (drain)	R <sub>thJC</sub>							
	11100							
SPECIFICATIONS (T <sub>J</sub> = 25 °C, u	nless otherw	rise noted)						
PARAMETER	SYMBOL		CONDITI	ONS	MIN.	TYP.	MAX.	UNIT
Static		1				Į	<u> </u>	Į
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0$	V, I <sub>D</sub> = -2	250 μA	-60	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference to	o 25 °C, I	<sub>D</sub> = -1 mA	-	-0.060	-	V/°C
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_0$	<sub>GS</sub> , I <sub>D</sub> = 2	50 μA	-2.0	_	-4.0	V
Gate-source leakage	I <sub>GSS</sub>	V <sub>G</sub>	$s = \pm 20^{10}$	V	-	-	± 100	nA
~	300		-		-	-	-100	
Zero gate voltage drain current	I <sub>DSS</sub>		$V_{DS} = -60 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$ $V_{DS} = -48 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 150 ^{\circ}\text{C}$			_	-500	μA
Drain-source on-state resistance	R <sub>DS(on)</sub>	50	1	) = -11 A <sup>b</sup>	-	-	0.14	Ω
Forward transconductance	9fs	V <sub>DS</sub> = -25	-		5.9	_	-	S
Dynamic	915	•DS - 2.	<b>, 1</b> 0 –		0.0			
Input capacitance	C <sub>iss</sub>	v			-	1100	-	
Output capacitance	C <sub>oss</sub>	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = -25 V, f = 1.0 MHz, see fig. 5		_	620	_	pF	
Reverse transfer capacitance	C <sub>rss</sub>			-	100	-		
Total gate charge	Qg				-	-	34	
Gate-source charge	Q <sub>gs</sub>	- I <sub>D</sub> = -1 8 J V <sub>GS</sub> = -10 V V <sub>DS</sub> = -48		<sub>0</sub> = -1 8 A, <sub>0S</sub> = -48 V,	-	-	9.9	nC
Gate-drain charge	Q <sub>gd</sub>	-	see fig. 6 and 13 b		-	-	16	
Turn-on delay time	t <sub>d(on)</sub>				-	18	-	
Rise time	t <sub>r</sub>	- Vpp = -3	0 V. In =	-18 A.	-	120	-	1
Turn-off delay time	t <sub>d(off)</sub>	$V_{DD} = -30 \text{ V}, I_D = -18 \text{ A},$ $R_q = 12 \Omega, R_D = 1.5 \Omega, \text{ see fig. } 10^{\text{ b}}$		-	20	-	ns	
Fall time	t <sub>f</sub>	1			-	58	-	
Gate input resistance	L <sub>D</sub>	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-	nH	
Internal drain inductance	L <sub>S</sub>			-	7.5	-		
Internal source inductance	R <sub>g</sub>	f = 1 MI	Hz, open	drain	0.7	-	3.9	Ω
Drain-Source Body Diode Characteristic	s							
Continuous source-drain diode current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p -n junction diode		-	-	-18	A	
Pulsed diode forward current <sup>a</sup>	I <sub>SM</sub>			-	-	-72	-	
Body diode voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C, I <sub>S</sub>	= -18 A,	$V_{GS} = 0 V^{b}$	-	-	-6.3	V
Body diode reverse recovery time	t <sub>rr</sub>	– T <sub>J</sub> = 25 °C, I <sub>F</sub> = -	19 1 41/	dt - 100 A/up b	-	100	200	ns
Body diode reverse recovery charge	Q <sub>rr</sub>	$I_{\rm J} = 25$ C, $I_{\rm F} = -$	10 A, Ul/	$a_1 = 100 \text{ A/} \mu \text{s}^{-1}$	-	0.28	0.52	μC
Forward turn-on time	t <sub>on</sub>	Intrinsic turn-	Intrinsic turn-on time is negligible (turn		-on is do	minated b	y L <sub>S</sub> and	L <sub>D</sub> )

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. Pulse width  $\leq$  300 µs; duty cycle  $\leq$  2 %

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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

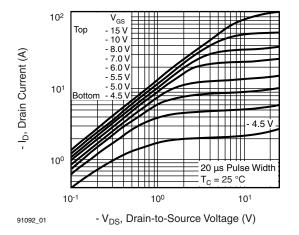


Fig. 1 - Typical Output Characteristics, T<sub>C</sub> = 25 °C

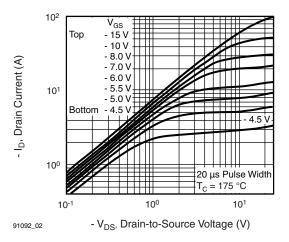


Fig. 2 - Typical Output Characteristics, T<sub>C</sub> = 175 °C

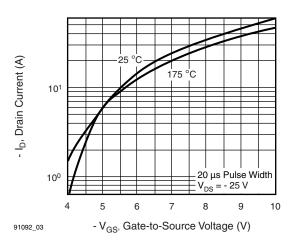


Fig. 3 - Typical Transfer Characteristics

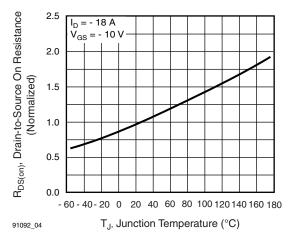


Fig. 4 - Normalized On-Resistance vs. Temperature

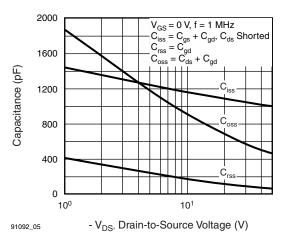


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

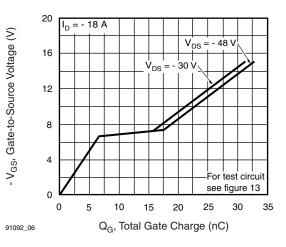


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

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3 For technical questions, contact: <u>hvm@vishay.com</u> Document Number: 91092

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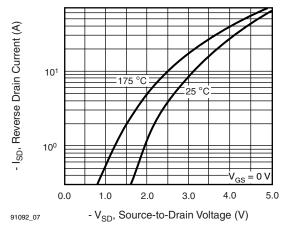


Fig. 7 - Typical Source-Drain Diode Forward Voltage

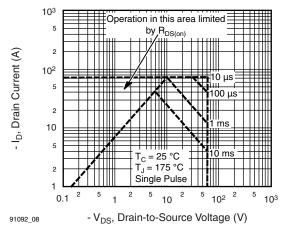


Fig. 8 - Maximum Safe Operating Area

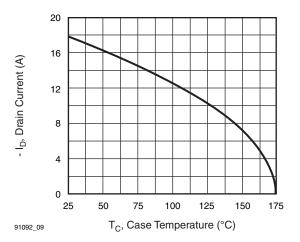


Fig. 9 - Maximum Drain Current vs. Case Temperature

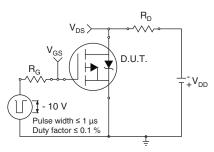


Fig. 10a - Switching Time Test Circuit

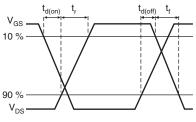


Fig. 10b - Switching Time Waveforms

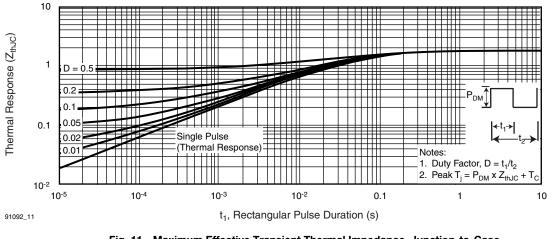


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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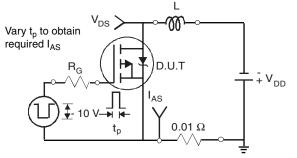


Fig. 12a - Unclamped Inductive Test Circuit

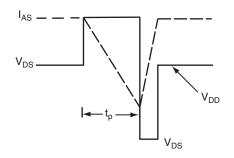


Fig. 12b - Unclamped Inductive Waveforms

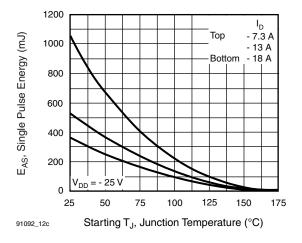


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

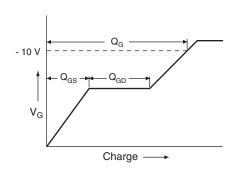


Fig. 13a - Basic Gate Charge Waveform

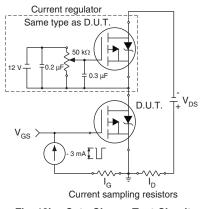


Fig. 13b - Gate Charge Test Circuit

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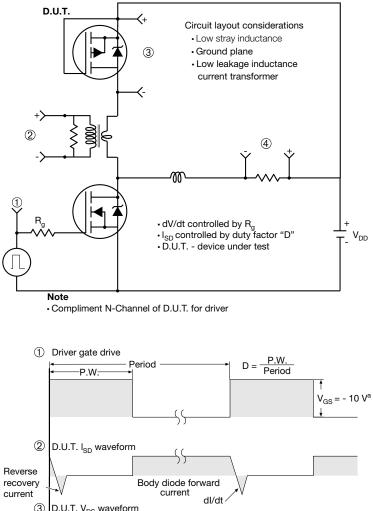
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#### Peak Diode Recovery dV/dt Test Circuit



 $\begin{array}{c} (2) \\ (2) \\ (2) \\ (3) \\ (2) \\$ 

a.  $V_{GS} = -5$  V for logic level and - 3 V drive devices

Fig. 14 - For P-Channel

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TO-220-1



DIM	MILLIN	METERS	INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
А	4.24	4.65	0.167	0.183
b	0.69	1.02	0.027	0.040
b(1)	1.14	1.78 0.045		0.070
С	0.36	0.61	0.61 0.014	
D	14.33	15.85	15.85 0.564	
E	9.96	10.52	0.392	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.10	6.71	0.240	0.264
J(1)	2.41	2.92	0.095	0.115
L	13.36	14.40	0.526	0.567
L(1)	3.33	4.04	0.131	0.159
ØP	3.53	3.94	0.139	0.155
Q	2.54	3.00	0.100	0.118

#### Note

• M\* = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM



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